3.3V CMOS ONE-TO-FOUR ADDRESS/CLOCK DRIVER

IDT74FCT163344A/C

FEATURES:

- 0.5 MICRON CMOS Technology
- Typical tsk(o) (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- Vcc = 3.3V ± 0.3V, Normal Range, or Vcc = 2.7V to 3.6V, Extended Range
- CMOS power levels (0.4 w typ. static)
- · Rail-to-rail output swing for increased noise margin
- Low Ground Bounce (0.3V typ.)
- · Inputs (except I/O) can be driven by 3.3V or 5V components
- · Available in TSSOP package

DESCRIPTION:

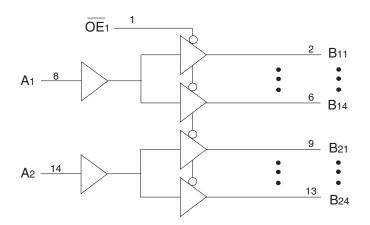
The FCT163344 is a 1:4 address/clock driver built using advanced dual metal CMOS technology. This high-speed, low power device provides the ability to fanout to memory arrays. Eight banks, each with a fanout of 4, and 3-state control provide efficient address distribution. One or more banks may be used for clock distribution.

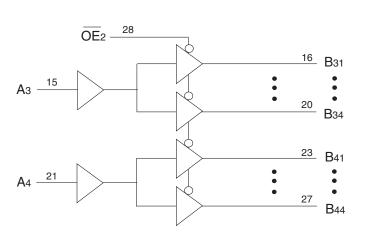
The FCT163344 has series current limiting resistors. These offer low ground bounce, minimal undershoot and controlled output fall times, reducing the need for external series terminating resistors.

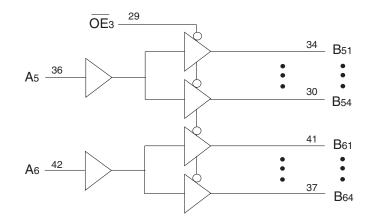
A large number of power and ground pins ensure reduced noise levels. All inputs are designed with hysteresis for improved noise margins.

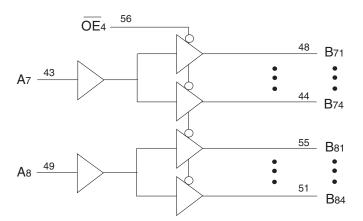
The inputs of the FCT163344 can be driven from either 3.3V or 5V device. This feature allows the use of these devices as translators in a mixed 3.3V/5V supply system.

FUNCTIONAL BLOCK DIAGRAM







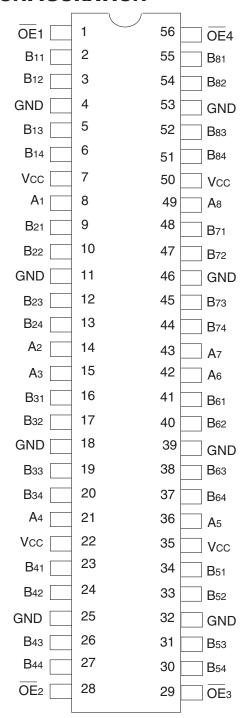


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INDUSTRIAL TEMPERATURE RANGE

SEPTEMBER 2009

PIN CONFIGURATION



TSSOP TOP VIEW

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +4.6	٧
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	–0.5 to 7	V
VTERM ⁽⁴⁾	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	V
Tstg	Storage Temperature	-65 to +150	°C
Іоит	DC Output Current	-60 to +60	mA

NOTES:

- 1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 2. Vcc terminals.
- 3. Input terminals.
- 4. Outputs and I/O terminals.

CAPACITANCE (TA = +25°C, F = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Тур.	Max.	Unit
CIN	Input Capacitance	VIN = 0V	3.5	6	pF
Соит	Output Capacitance	Vout = 0V	3.5	7	pF

NOTE:

1. This parameter is measured at characterization but not tested.

PIN DESCRIPTION

Pin Names	Description
ŌĒx	3-State Output Enable Inputs (Active LOW)
Ах	Inputs
Вхх	3-State Outputs

FUNCTION TABLE(1)

Inputs		Outputs
ŌĒx	Ах	Вхх
L	L	L
L	Н	Н
Н	Х	Z

- 1. H = HIGH Voltage Level
 - L = LOW Voltage Level
 - X = Don't Care
 - Z = High-impedance

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

 $Following \ Conditions \ Apply \ Unless \ Otherwise \ Specified:$

Industrial: TA = -40°C to +85°C, VCC = 2.7V to 3.6V

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
ViH	Input HIGH Level (Input pins)	Guaranteed Logic HIGH Level		2	_	5.5	V
	Input HIGH Level (I/O pins)			2	_	Vcc+0.5	
VIL	Input LOW Level (Input and I/O pins)	Guaranteed Logic LOW Level		-0.5	_	0.8	V
Іін	Input HIGH Current (Input pins)	Vcc = Max.	VI = 5.5V	_	_	±1	
	Input HIGH Current (I/O pins)		VI = VCC	_	_	±1	μA
lıL	Input LOW Current (Input pins)		Vı = GND	_	_	±1	
	Input LOW Current (I/O pins)		Vı = GND	_	_	±1	
Іоzн	High Impedance Output Current	Vcc = Max.	Vo = Vcc	_	_	±1	μA
lozL	(3-State Output pins)		Vo = GND	<u> </u>	_	±1	
Vik	Clamp Diode Voltage	VCC = Min., IIN = -18mA		<u> </u>	-0.7	-1.2	V
lodн	Output HIGH Current	Vcc = 3.3V, Vin = Vih or Vil., Vo = 1.5V ⁽³⁾		-36	-60	-110	mA
lodl	Output LOW Current	Vcc = 3.3V, Vin = Vih or Vil., Vo = 1.5V ⁽³⁾		50	90	200	mA
Vон	Output HIGH Voltage	Vcc = Min.	IOH = -0.1mA	Vcc-0.2	_	_	
		VIN = VIH or VIL	Iон = -3mA	2.4	3	_	V
		VCC = 3V	Іон = –8mA	2.4(5)	3	_	
		VIN = VIH or VIL					
Vol	Output LOW Voltage	VCC = Min.	IOL = 0.1mA		_	0.2	
		VIN = VIH or VIL	IOL = 16mA	_	0.2	0.4	
			IOL = 24mA	_	0.3	0.55	V
		VCC = 3V	IOL = 24mA	_	0.3	0.5	
		VIN = VIH or VIL					
los	Short Circuit Current ⁽⁴⁾	Vcc = Max., Vo = GND ⁽³⁾		-60	-135	-240	mA
VH	Input Hysteresis	_		_	150	_	mV
ICCL ICCH ICCZ	Quiescent Power Supply Current	Vcc = Max. Vin = GND or Vcc		_	0.1	10	μА

- 1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 3.3V, $+25^{\circ}C$ ambient.
- 3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- 4. This parameter is guaranteed but not tested.
- 5. VoH = Vcc-0.6V at rated current.

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Unit
∆lcc	Quiescent Power Supply Current TTL Inputs HIGH	$V_{CC} = Max.$ $V_{IN} = V_{CC} - 0.6V^{(3)}$		_	2	30	μA
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc = Max. Outputs Open OEx = GND One Input Bit Togging Four Output Bits Togging 50% Duty Cycle	VIN = VCC VIN = GND	1	230	320	μΑ/ MHz
Ic	Total Power Supply Current ⁽⁶⁾	Vcc = Max.,Outputs Open fi = 10MHz 50% Duty Cycle	VIN = VCC VIN = GND	_	2.3	3.2	mA
		OEx = GND One Input Bit Toggling Four Output Bits Togging	VIN = VCC - 0.6V VIN = GND	-	2.3	3.2	
		Vcc = Max.,Outputs Open fi = 2.5MHz 50% Duty Cycle	VIN = VCC VIN = GND	_	4.6	6.4 ⁽⁵⁾	
		OEx = GND Eight Input Bits Toggling 32 Output Bits Togging	VIN = VCC - 0.6V VIN = GND	_	4.6	6.5 ⁽⁵⁾	

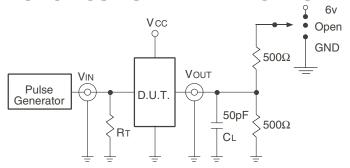
- 1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 3.3V, +25°C ambient.
- 3. Per TTL driven input. All other inputs at Vcc or GND.
- 4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- 5. Values for these conditions are examples of the lcc formula. These limits are guaranteed but not tested.
- 6. IC = IQUIESCENT + INPUTS + IDYNAMIC
 - $IC = ICC + \Delta ICC DHNT + ICCD (fcpNcp/2 + fiNi)$
 - Icc = Quiescent Current (IccL, IccH and Iccz)
 - Δ Icc = Power Supply Current for a TTL High Input
 - DH = Duty Cycle for TTL Inputs High
 - NT = Number of TTL Inputs at DH
 - ICCD = Dynamic Current caused by an Input Transition Pair (HLH or LHL)
 - fcp = Clock Frequency for Register Devices (Zero for Non-Register Devices)
 - NCP = Number of Clock Inputs at fCP
 - fi = Input Frequency
 - Ni = Number of Inputs at fi

SWITCHING CHARACTERISTICS OVER OPERATING RANGE(1)

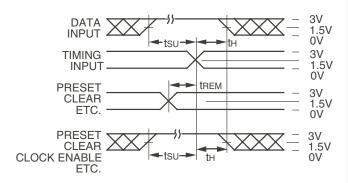
			FCT16	53344A	FCT16	3344C	
Symbol	Parameter	Condition ⁽²⁾	Min. ⁽³⁾	Max.	Min. ⁽³⁾	Max.	Unit
t PLH	Propagation Delay	CL = 50pF	1.5	4.8	1.5	4.3	ns
t PHL	Ax to Bxx	$RL = 500\Omega$					
tpzh	Output Enable Time		1.5	6.2	1.5	5.8	ns
tpzl	OEx to Bxx						
tphz	Output Disable Time		1.5	5.6	1.5	5.2	ns
tPLZ	OEx to Bxx						
tsk(b)	Skew between outputs of the same bank and		_	0.5	_	0.35	ns
	same package (same transition) ^(4,5)						
tsk(o)	Skew between outputs of all banks of the same		_	0.5	_	0.5	ns
	package (A1 - A8 tied together) ^(4,5)						

- 1. Propagation Delays and Enable/Disable times are with Vcc = 3.3V ±0.3V, Normal Range. For Vcc = 2.7V to 3.6V, Extended Range, all Propagation Delays and Enable/Disable times should be degraded by 20%.
- 2. See test circuit and waveforms.
- 3. Minimum limits are guaranteed but not tested on Propagation Delays.
- 4. Skew between any two outputs, of the same package, switching in the same direction. This parameter is guaranteed by design.
- 5. This parameter is guaranteed but not tested. Skew is not guaranteed when Vcc < 0.3V.

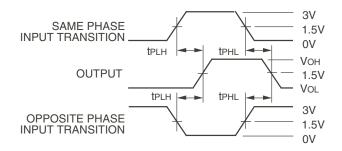
TEST CIRCUITS AND WAVEFORMS



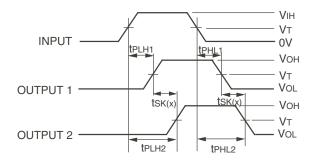
Test Circuits for All Outputs



Set-up, Hold, and Release Times



Propagation Delay



tsk(x) = |tplue - tplue| or |tphue - tphue|

Output Skew - tsk(x)

NOTES:

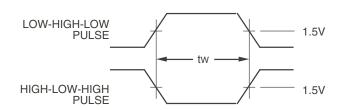
- I. For tsk(o) OUTPUT1 and OUTPUT2 are any two outputs.
- 2. For tsk(b) OUTPUT1 and OUTPUT2 are in the same bank.

SWITCH POSITION

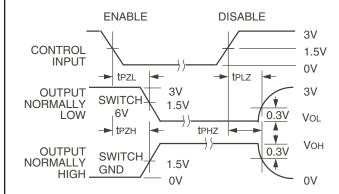
Test	Switch
Open Drain Disable Low Enable Low	6V
Disable High Enable High	GND
All Other Tests	Open

DEFINITIONS:

- CL = Load capacitance: includes jig and probe capacitance.
- RT = Termination resistance: should be equal to ZouT of the Pulse Generator.



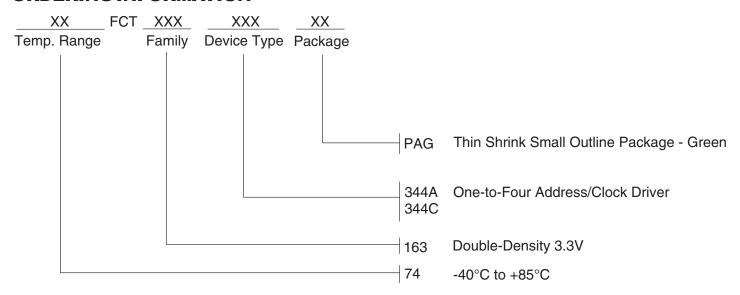
Pulse Width



Enable and Disable Times

- 1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
- 2. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2.5ns; tR \leq 2.5ns.
- 3. if Vcc is below 3V, input voltage swings should be adjusted not to exceed Vcc.

ORDERING INFORMATION



Datasheet Document History

09/10/09 Pg.7 Updated the ordering information by removing the "IDT" notation and non RoHS part.

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